



PHOTONIC INTEGRATED SWITCHING AND ROUTING

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PHOTONIC INTEGRATED CIRCUITS



Photonic integrated circuits are showing ever-increasing <u>Technology Readiness Levels</u>, with new applications becoming available with each passing year.

Many advantages:

- Batch Fabrication Economy.
- Large bandwidth and high speed
- Low power and high reliability

Not only limited to communications and data transfer



<u>General-purpose</u> programmable photonic devices

To this end, the research activity focuses on the <u>vertical</u> <u>bottom-up</u> design and simulation of <u>complex PICs</u>, abstracting the performances from the <u>device layer</u> to the <u>circuit and</u> <u>application</u>.





PICs - DEVICES



Many fundamental devices can be used as *building blocks* for more complex functionalities:

MicroRing Resonators

Mach Zehnder Interferometers

Through Port (dB)

-0.15

-0.2

0.25

-0.3

-0.35

-0.4

1.53

1.535

1.54

1.545 1.55

Wavelength (μ m)

Phase Thermal Control Input Lc $\Delta \Phi = \pi$ $\Delta \Phi = \pi$ $\Delta d\Phi = \pi$

-30 (**(B)** -50 Loci (**(B)** -60 -60

-70

-80

Through

Channels Occupation

1.56 1.565

Drop

1.555





Grating-Assisted Couplers



3

SIMULATION & DESIGN METHODS



Following the vertical approach, different models and simulation methods are used for the <u>design and validation</u> of the fundamental components:

- **Numerical simulations** in the available Synopsys platforms (BPM, CMT, ModeSolve, FDTD, MultiPhysisics)
- **Analytical models** (when available and effective)
- **Circuit-model** abstraction for the higher layer simulations (Optsim DSP)

By combining the appropriate methods the simulation of large-scale circuits can be made more <u>efficient and fast</u> while retaining the same <u>accuracy</u>.



VERTICAL DESIGN APPROACH

-MOG-

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The response of the designed component is then used to compile and simulate the largerscale PICs, trying to maintain the <u>bottom-up</u> <u>approach and generality.</u>

A <u>cohesive design pipeline</u> can be established for <u>multi-faceted</u> problems by interfacing the different simulation platforms, ranging from the production mask requirements to the materials and waveguide geometry.

<u>Machine-Learning</u> (ML) and optimization techniques have also been deployed in the <u>inverse-design</u> of components and their characterization for large-scale circuits.



APPLICATION – BENEŠ NETWORKS





<u>NxN Beneš switching networks</u> represent a typical multistage topology both in photonic and electronic switching systems.

We developed a design suite to automate the design of <u>arbitrary-size</u> topologies, allowing <u>quick testing</u> and comparison of different device implementation and control strategies.

Based on the gathered data we deployed a ML agent to estimate the <u>transmission</u> <u>impairments</u> and optimal <u>routing strategies</u> for these devices, reducing the complexity and computational cost of the analysis.

APPLICATION - WSS



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Measured OSNR at receiver side

3 hops

Targeting Dense WDM applications we developed and simulated a <u>modular and scalable</u> architecture for a multi-band <u>Wavelength-Selective Switch (WSS).</u> Due to the large component number and footprint, the vertical approach is mandatory to ensure

the *reliability and accuracy* of the model.

We showcased a fully integrated solution capable of DWDM switching coupled with a straightforward <u>penalty</u> <u>prediction scheme</u>, allowing the abstraction of the component penalties from the device to the network level.



Hist Count 10





THANK YOU FOR YOUR ATTENTION

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